

CDRH74NP-100MT

Wire Wound SMD Power Inductor

FEATURES

- High saturation current, low DCR
- Suitable for surface mounting equipment
- Close magnetic circuit design reduce leakage
- Operate temperature range $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$ (Including self temp. rise)
- RoHS compliant

APPLICATIONS

- Power supply choke for small electrical equipments such as DVC, LCD display, notebook, communication equipment, OA equipment and so on.

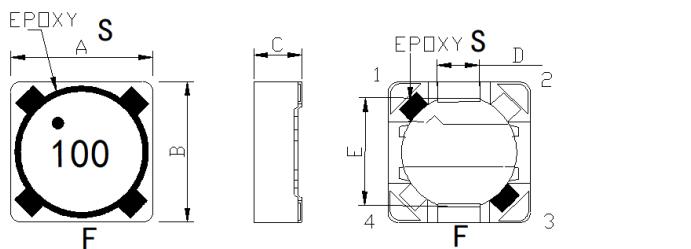
Explanation of Part Number

CDRH 74 NP -100 M T

1 2 3 4 5 6

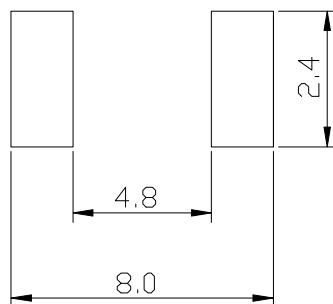
- ◆ 1:Product Series:Wire Wound SMD Power Inductor
- ◆ 2:Dimensions:
- ◆ 3: Material Code:
- ◆ 4: Initial inductance value: 100 = 10uH
- ◆ 5:Tolerance of Inductance:M: $\pm 20\%$
- ◆ 6:Packing:Tape Carrier Package

Dimensions: [mm]



A: 7.5 mm Max
 B: 7.5 mm Max
 C: 4.50mm Max
 D: 2.0 \pm 0.2 mm
 E: 5.1 \pm 0.2mm

LAND PATTERN DIMENSIONS: [mm]



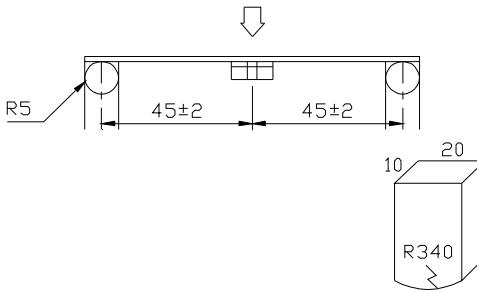
Electrical Properties:

MetalLions PT/NO.	Inductance L(μ H)	Test Frequency	Resistance RDC($m\Omega$) Max.	I _{sat} (A)Max	Marking
CDRH74NP-100MT	% \pm 20%	100kHz/0.25V	49	1.84	100

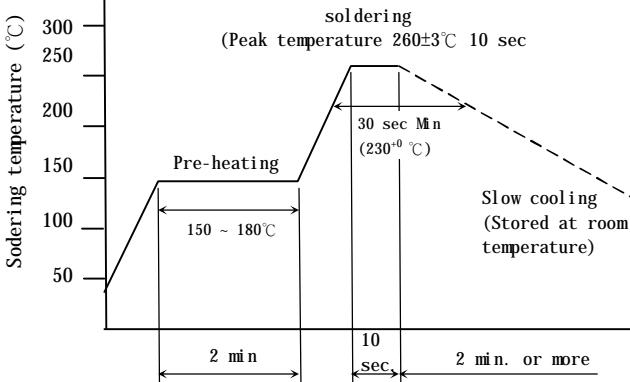
※I_{sat} : Based on inductance change ($\Delta L/L_0$: drop 35% Max.)

Reliability and Test Condition

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	$\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage or electrical damage.	The sample shall be soldered onto the printed circuit board in figure 1 and a load applied until the figure in the arrow direction is made approximately 3mm.(keep time 30 seconds) PCB dimension shall the page 7/9 F(Pressurization)  PRESSURE ROD figure-1
Vibration	$\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage.	The sample shall be soldered onto the printed circuit board and when a vibration having an amplitude of 1.52mm and a frequency of from 10 to 55Hz/1 minute repeated should be applied to the 3 directions (X,Y,Z) for 2 hours each. (A total of 6 hours)
Solderability	New solder More than 90%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of 130~150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5°C. More than 90% of the electrode sections shall be covered with new solder smoothly when the sample is taken out of the solder bath.

MECHANICAL

TEST ITEM	SPECIFICATION	
Resistance to Soldering heat (reflow soldering)	<p>There shall be no damage or problems.</p> <p>Temperature profile of reflow soldering</p>  <p>The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.</p> <p>The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.</p>	

ELECTRICAL

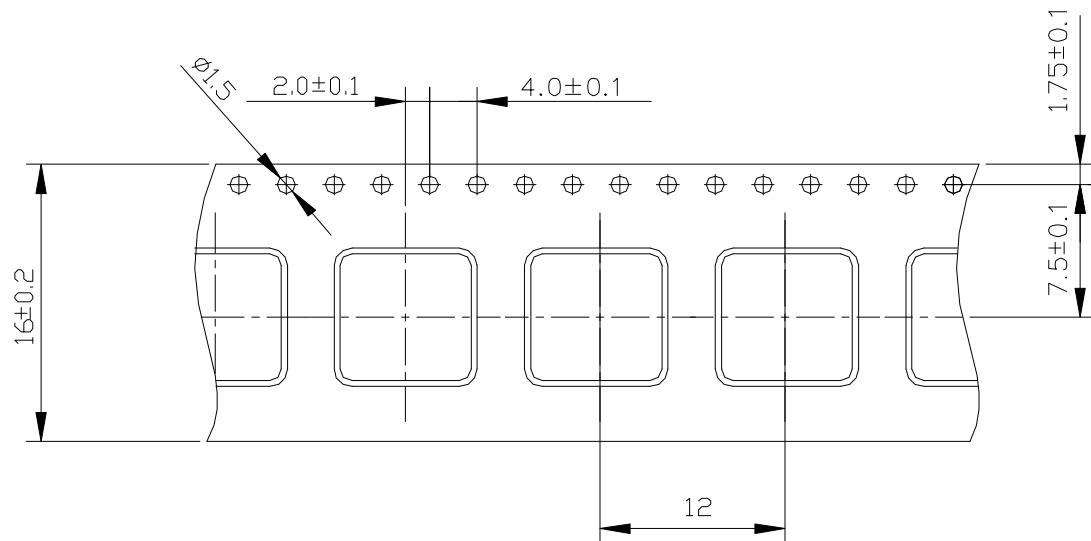
TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation resistance	<p>There shall be no other damage or problems.</p>	<p>DC 100V voltage shall be applied across this sample of top surface and the terminal.</p> <p>The insulation resistance shall be more than $1 \times 10^8 \Omega$.</p>
Dielectric withstand voltage	<p>There shall be no other damage or problems.</p>	<p>AC 100V voltage shall be applied for 1 minute across the top surface and the terminal of this sample</p>
Temperature characteristics	<p>$\Delta L/L20^\circ\text{C} \leq \pm 10\%$</p> <p>0~2000 ppm/°C</p>	<p>The test shall be performed after the sample has stabilized in an ambient temperature of -20 to +85°C, and the value calculated based on the value applicable in a normal temperature and normal humidity shall be $\Delta L/L20^\circ\text{C} \leq \pm 10\%$.</p>

ENVIRONMENT CHARACTERISTICS

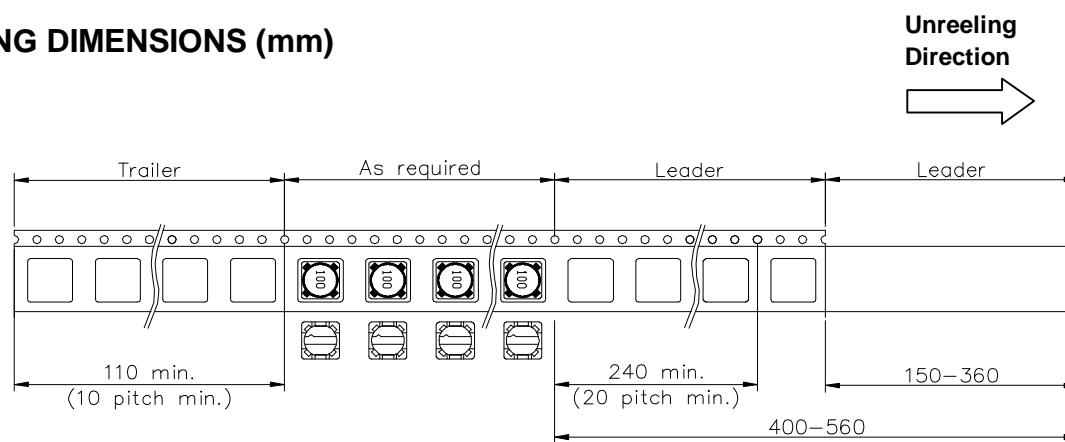
TEST ITEM	SPECIFICATION																
High temperature storage	$\Delta L/Lo \leq \pm 5\%$ There shall be no mechanical damage.	The sample shall be left for 96 ± 4 hours in an atmosphere with a temperature of $85 \pm 2^\circ\text{C}$ and a normal humidity. Upon completion of the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.															
Low temperature storage	$\Delta L/Lo \leq \pm 5\%$ There shall be no mechanical damage.	The sample shall be left for 96 ± 4 hours in an atmosphere with a temperature of $-25 \pm 3^\circ\text{C}$. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.															
Change of temperature	$\Delta L/Lo \leq \pm 5\%$ There shall be no other damage of problems	The sample shall be subject to 5 continuous cycles, such as shown in the table 2 below and then it shall be subjected to standard atmospheric conditions for 1 hour, after which measurement shall be made.															
table 2		<table border="1"> <thead> <tr> <th></th> <th>Temperature</th> <th>Duration</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>$-25 \pm 3^\circ\text{C}$ (Thermostat No.1)</td> <td>30 min.</td> </tr> <tr> <td>2</td> <td>Standard atmospheric</td> <td>No.1 → No.2</td> </tr> <tr> <td>3</td> <td>$85 \pm 2^\circ\text{C}$ (Thermostat No.2)</td> <td>30 min.</td> </tr> <tr> <td>4</td> <td>Standard atmospheric</td> <td>No.2 → No.1</td> </tr> </tbody> </table>		Temperature	Duration	1	$-25 \pm 3^\circ\text{C}$ (Thermostat No.1)	30 min.	2	Standard atmospheric	No.1 → No.2	3	$85 \pm 2^\circ\text{C}$ (Thermostat No.2)	30 min.	4	Standard atmospheric	No.2 → No.1
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4	Standard atmospheric	No.2 → No.1															
Moisture storage	$\Delta L/Lo \leq \pm 5\%$ There shall be no mechanical damage.	The sample shall be left for 96 ± 4 hours in a temperature of $40 \pm 2^\circ\text{C}$ and a humidity (RH) of 90~95%. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour.															
Test conditions : The sample shall be reflow soldered onto the printed circuit board in every test.																	

PACKAGING

CARRIER TAPE DIMENSIONS (mm)



TAPING DIMENSIONS (mm)



REEL DIMENSIONS (mm)



Packing Quantity: 1000pcs/Reel